

EconoPACK™2 module with TRENCHSTOP™ IGBT7 and emitter controlled 7 diode and NTC

Features

- Electrical features
 - $V_{CES} = 1200\text{ V}$
 - $I_{C\text{ nom}} = 100\text{ A} / I_{CRM} = 200\text{ A}$
 - TRENCHSTOP™ IGBT7
 - Low $V_{CE,sat}$
 - Overload operation up to 175°C
- Mechanical features
 - High power and thermal cycling capability
 - Integrated NTC temperature sensor
 - Copper base plate
 - Al_2O_3 substrate with low thermal resistance
 - Solder contact technology



Typical appearance

Potential applications

- Auxiliary inverters
- Motor drives
- Servo drives

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

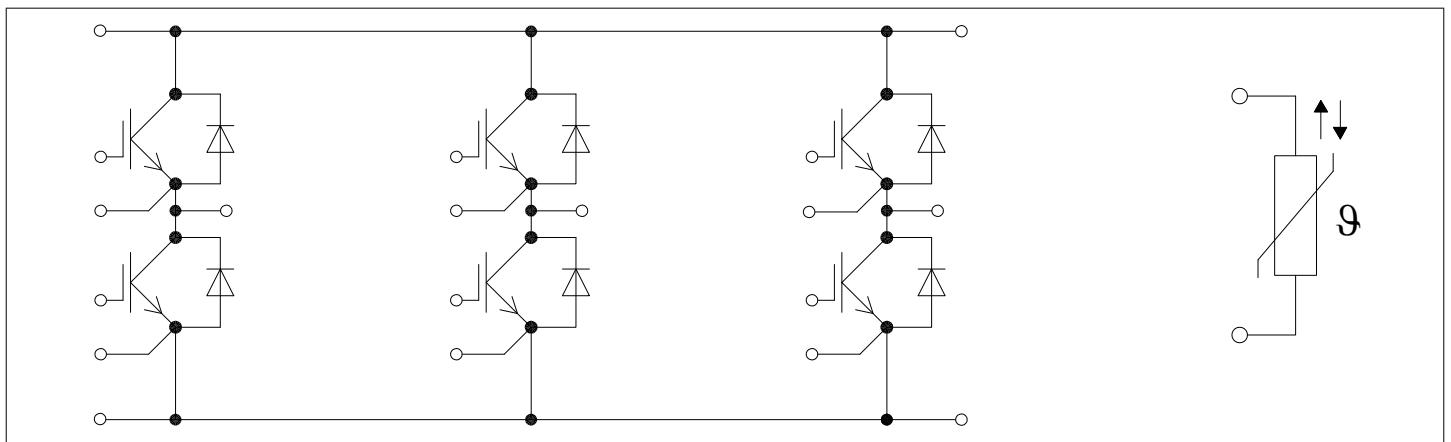


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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	2.5	kV
Material of module baseplate			Cu	
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	d_{Creep}	terminal to heatsink	10.0	mm
Clearance	d_{Clear}	terminal to heatsink	7.5	mm
Comparative tracking index	CTI		>200	
Relative thermal index (electrical)	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{sCE}			26		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25^\circ\text{C}$, per switch		2.7		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting torque for module mounting	M	- Mounting according to valid application note	3		6	Nm
Weight	G			180		g

Note: The current under continuous operation is limited to 50 A rms per connector pin.

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		$T_{vj} = 25^\circ\text{C}$	1200	V
Continuous DC collector current	I_{CDC}	$T_{vj \max} = 175^\circ\text{C}$	$T_C = 95^\circ\text{C}$	100	A
Repetitive peak collector current	I_{CRM}	$t_p = 1 \text{ ms}$		200	A
Gate-emitter peak voltage	V_{GES}			±20	V

Table 4 **Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 100\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		1.50	1.80	V
			$T_{vj} = 125\ ^\circ C$		1.64		
			$T_{vj} = 175\ ^\circ C$		1.72		
Gate threshold voltage	V_{GEth}	$I_C = 2.5\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$		5.15	5.80	6.45	V
Gate charge	Q_G	$V_{GE} = \pm 15\ V, V_{CE} = 600\ V$			1.8		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\ ^\circ C$			1.5		Ω
Input capacitance	C_{ies}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			21.7		nF
Reverse transfer capacitance	C_{res}	$f = 100\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			0.076		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1200\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			0.01	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$				100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 100\ A, V_{CE} = 600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 3.9\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.175		μs
			$T_{vj} = 125\ ^\circ C$		0.192		
			$T_{vj} = 175\ ^\circ C$		0.205		
Rise time (inductive load)	t_r	$I_C = 100\ A, V_{CE} = 600\ V, V_{GE} = \pm 15\ V, R_{Gon} = 3.9\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.046		μs
			$T_{vj} = 125\ ^\circ C$		0.051		
			$T_{vj} = 175\ ^\circ C$		0.053		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 100\ A, V_{CE} = 600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 3.9\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.309		μs
			$T_{vj} = 125\ ^\circ C$		0.389		
			$T_{vj} = 175\ ^\circ C$		0.442		
Fall time (inductive load)	t_f	$I_C = 100\ A, V_{CE} = 600\ V, V_{GE} = \pm 15\ V, R_{Goff} = 3.9\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.104		μs
			$T_{vj} = 125\ ^\circ C$		0.198		
			$T_{vj} = 175\ ^\circ C$		0.248		
Turn-on energy loss per pulse	E_{on}	$I_C = 100\ A, V_{CE} = 600\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 3.9\ \Omega, di/dt = 1650\ A/\mu s (T_{vj} = 175\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		10.5		mJ
			$T_{vj} = 125\ ^\circ C$		14.7		
			$T_{vj} = 175\ ^\circ C$		16.8		
Turn-off energy loss per pulse	E_{off}	$I_C = 100\ A, V_{CE} = 600\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 3.9\ \Omega, dv/dt = 3030\ V/\mu s (T_{vj} = 175\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		6.68		mJ
			$T_{vj} = 125\ ^\circ C$		10.8		
			$T_{vj} = 175\ ^\circ C$		12.8		
SC data	I_{SC}	$V_{GE} \leq 15\ V, V_{CC} = 800\ V, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	$t_P \leq 8\ \mu s, T_{vj} = 150\ ^\circ C$		370		A
			$t_P \leq 7\ \mu s, T_{vj} = 175\ ^\circ C$		350		

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, junction to case	R_{thJC}	per IGBT			0.371	K/W
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, $\lambda_{grease} = 1 \text{ W/(m}^2\text{K)}$		0.135		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		175	°C

Note: $T_{vj\text{ op}} > 150^\circ\text{C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25^\circ\text{C}$	1200	V
Continuous DC forward current	I_F			100	A
Repetitive peak forward current	I_{FRM}	$t_P = 1 \text{ ms}$		200	A
I^2t - value	I^2t	$t_P = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125^\circ\text{C}$	1260	A^2s
			$T_{vj} = 175^\circ\text{C}$	1060	

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 100 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		1.72	V
			$T_{vj} = 125^\circ\text{C}$		1.59	
			$T_{vj} = 175^\circ\text{C}$		1.52	
Peak reverse recovery current	I_{RM}	$V_R = 600 \text{ V}, I_F = 100 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1650 \text{ A}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		57.7	A
			$T_{vj} = 125^\circ\text{C}$		77.4	
			$T_{vj} = 175^\circ\text{C}$		88.3	
Recovered charge	Q_r	$V_R = 600 \text{ V}, I_F = 100 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1650 \text{ A}/\mu\text{s} (T_{vj} = 175^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		6.9	μC
			$T_{vj} = 125^\circ\text{C}$		15.4	
			$T_{vj} = 175^\circ\text{C}$		19.4	

(table continues...)

Table 6 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Reverse recovery energy	E_{rec}	$V_R = 600\text{ V}$, $I_F = 100\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 1650\text{ A}/\mu\text{s}$ ($T_{vj} = 175\text{ °C}$)	$T_{vj} = 25\text{ °C}$	2.04		mJ
			$T_{vj} = 125\text{ °C}$	4.61		
			$T_{vj} = 175\text{ °C}$	6.66		
Thermal resistance, junction to case	R_{thJC}	per diode			0.592	K/W
Thermal resistance, case to heat sink	R_{thCH}	per diode, $\lambda_{grease} = 1\text{ W}/(\text{m}^2\text{K})$		0.148		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		175	°C

Note: $T_{vj\text{ op}} > 150\text{ °C}$ is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

4 NTC-Thermistor

Table 7 Characteristic values

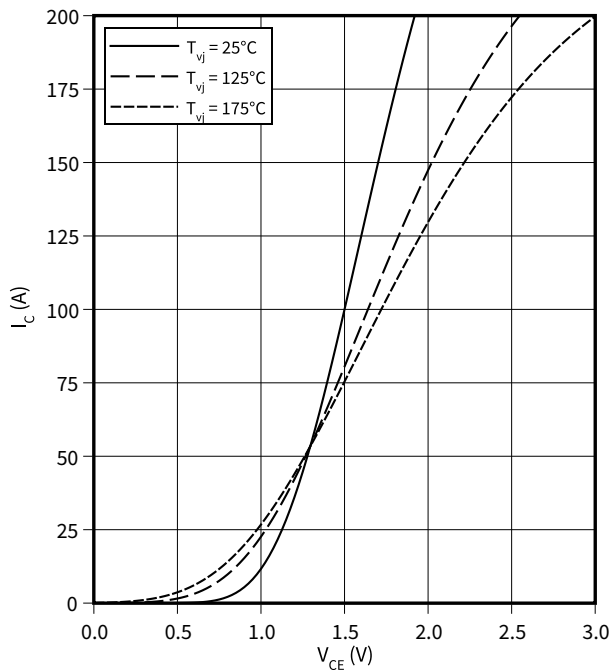
Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25\text{ °C}$		5		kΩ
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100\text{ °C}$, $R_{100} = 493\text{ Ω}$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25\text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$		3433		K

Note: Specification according to the valid application note.

5 Characteristics diagrams

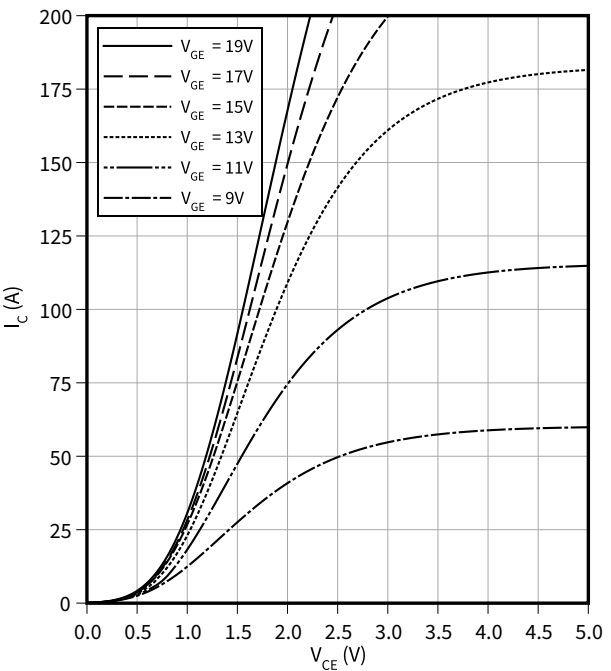
output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $V_{GE} = 15\text{ V}$



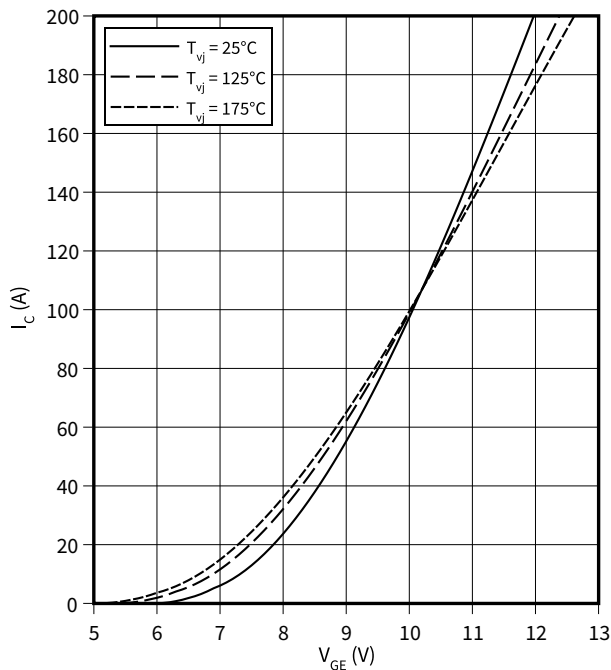
output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $T_{vj} = 175^\circ\text{C}$



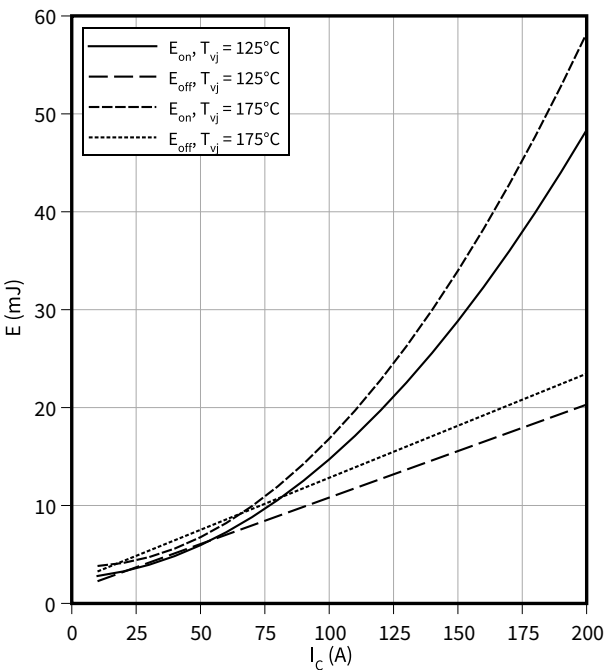
Transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



switching losses (typical), IGBT, Inverter

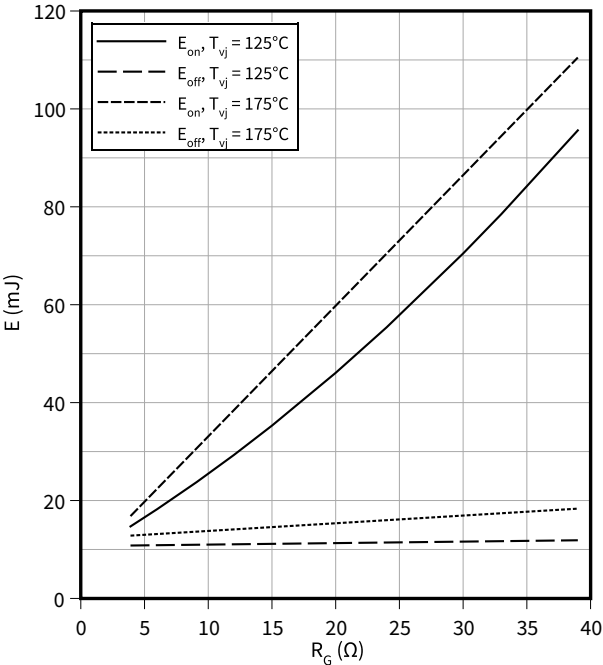
$E = f(I_C)$
 $R_{Goff} = 3.9\ \Omega$, $R_{Gon} = 3.9\ \Omega$, $V_{GE} = \pm 15\text{ V}$, $V_{CE} = 600\text{ V}$



5 Characteristics diagrams

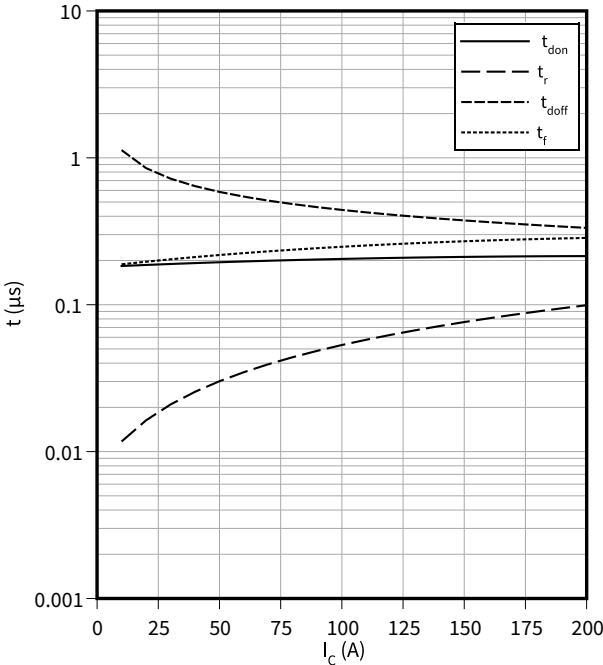
switching losses (typical), IGBT, Inverter

$E = f(R_G)$
 $I_C = 100\text{ A}$, $V_{CE} = 600\text{ V}$, $V_{GE} = \pm 15\text{ V}$



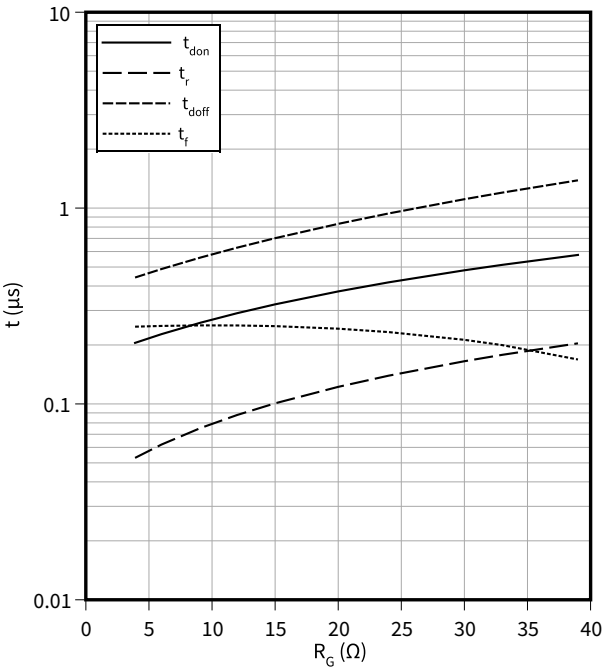
switching times (typical), IGBT, Inverter

$t = f(I_C)$
 $R_{Goff} = 3.9\text{ }\Omega$, $R_{Gon} = 3.9\text{ }\Omega$, $V_{GE} = \pm 15\text{ V}$, $V_{CE} = 600\text{ V}$, $T_{vj} = 175\text{ }^\circ\text{C}$



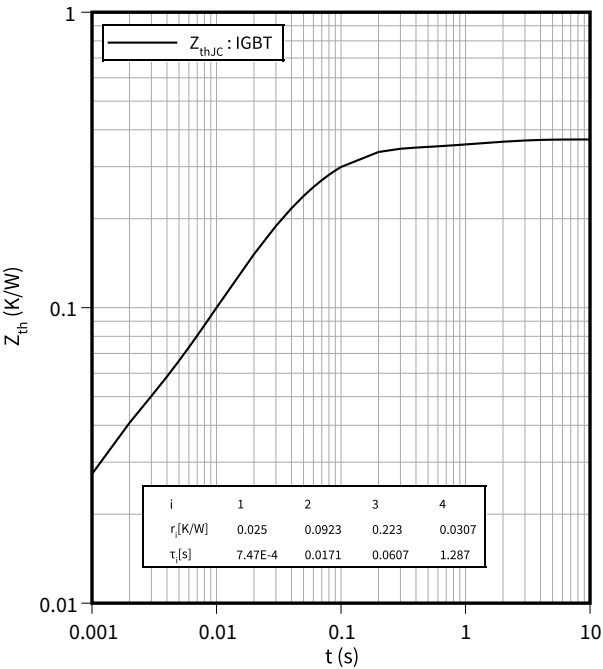
switching times (typical), IGBT, Inverter

$t = f(R_G)$
 $V_{GE} = \pm 15\text{ V}$, $I_C = 100\text{ A}$, $V_{CE} = 600\text{ V}$, $T_{vj} = 175\text{ }^\circ\text{C}$



transient thermal impedance , IGBT, Inverter

$Z_{th} = f(t)$

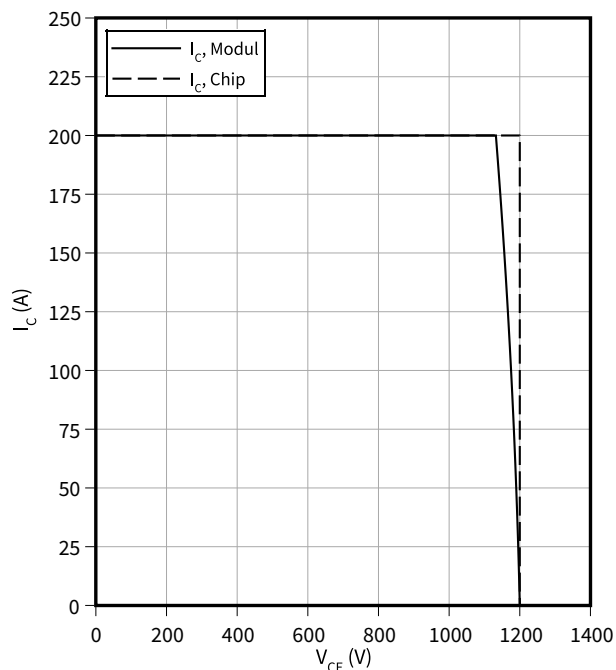


5 Characteristics diagrams

reverse bias safe operating area (RBSOA), IGBT, Inverter

$$I_C = f(V_{CE})$$

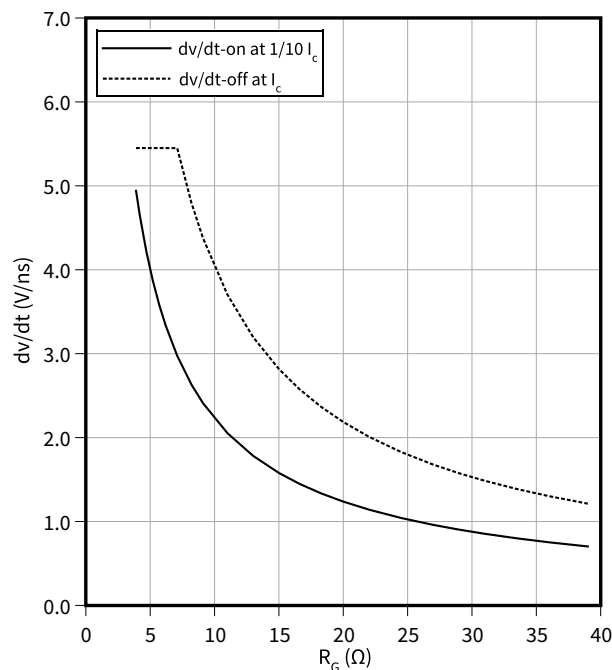
$R_{Goff} = 3.9 \Omega$, $V_{GE} = \pm 15 V$, $T_{vj} = 175 ^\circ C$



Voltage slope (typical), IGBT, Inverter

$$dv/dt = f(R_G)$$

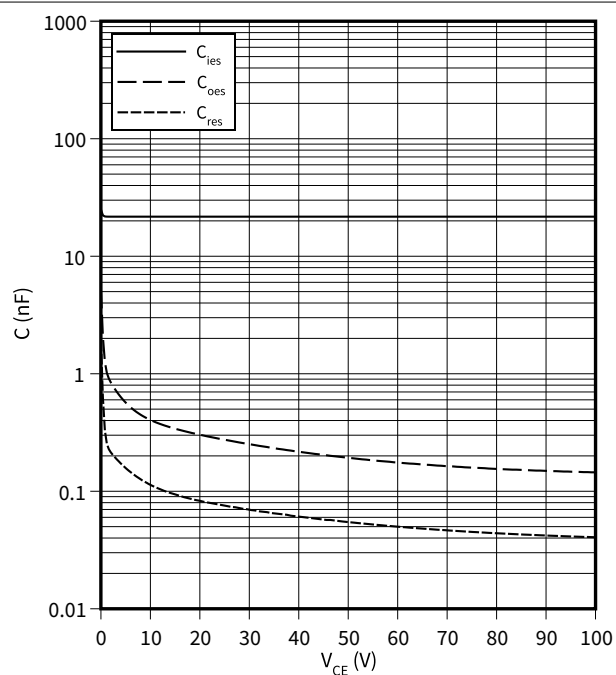
$I_C = 100 A$, $V_{CE} = 600 V$, $V_{GE} = \pm 15 V$, $T_{vj} = 25 ^\circ C$



capacity characteristic (typical), IGBT, Inverter

$$C = f(V_{CE})$$

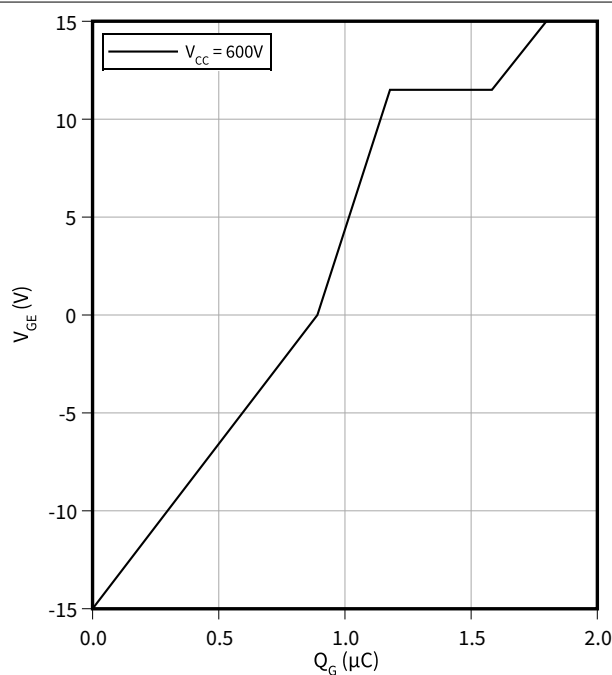
$f = 100 kHz$, $V_{GE} = 0 V$, $T_{vj} = 25 ^\circ C$



gate charge characteristic (typical), IGBT, Inverter

$$V_{GE} = f(Q_G)$$

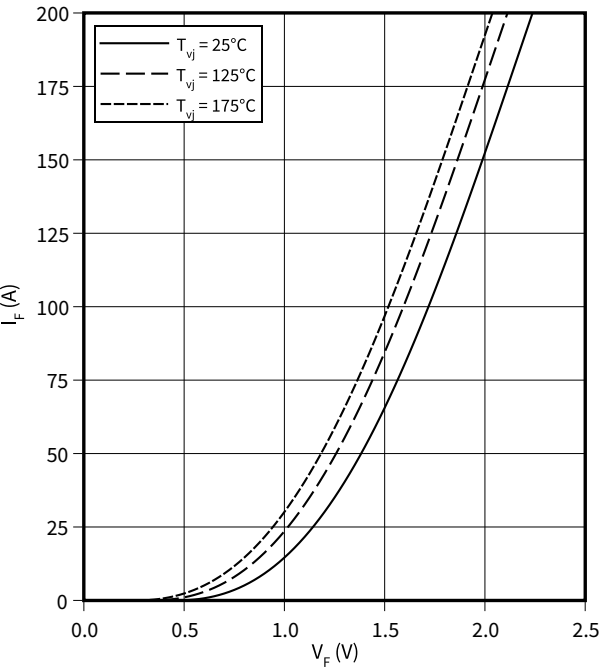
$I_C = 100 A$, $T_{vj} = 25 ^\circ C$



5 Characteristics diagrams

forward characteristic (typical), Diode, Inverter

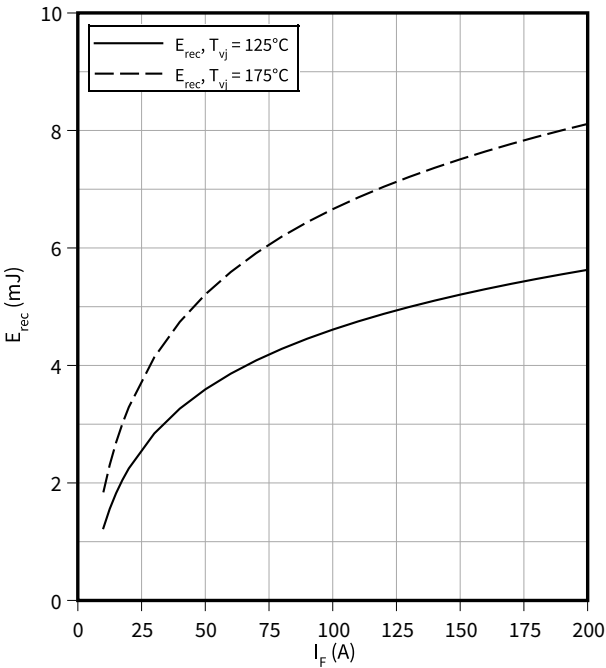
$I_F = f(V_F)$



switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$

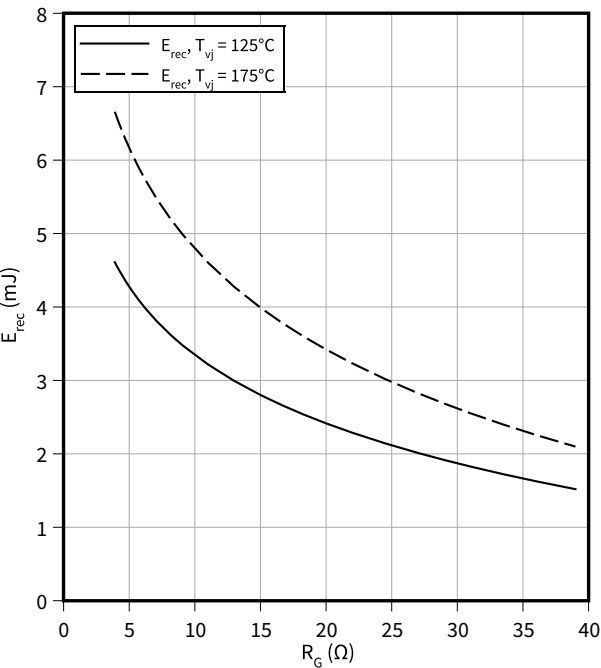
$R_{Gon} = 3.9\ \Omega, V_R = 600\ \text{V}$



switching losses (typical), Diode, Inverter

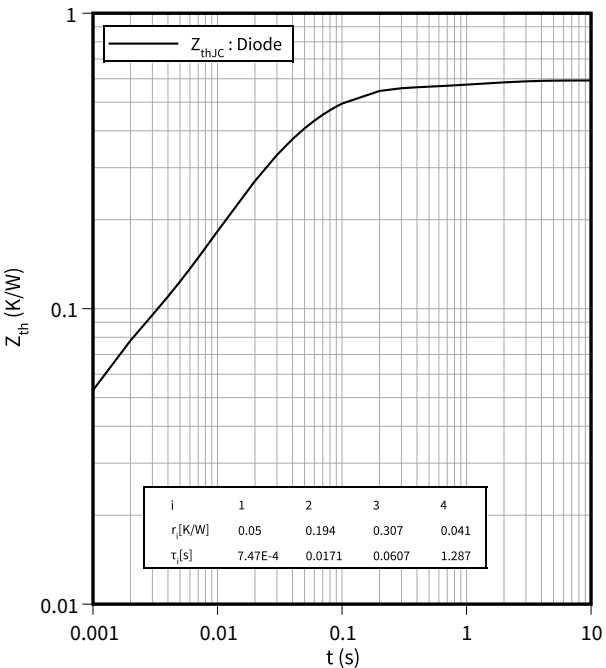
$E_{rec} = f(R_G)$

$I_F = 100\ \text{A}, V_R = 600\ \text{V}$



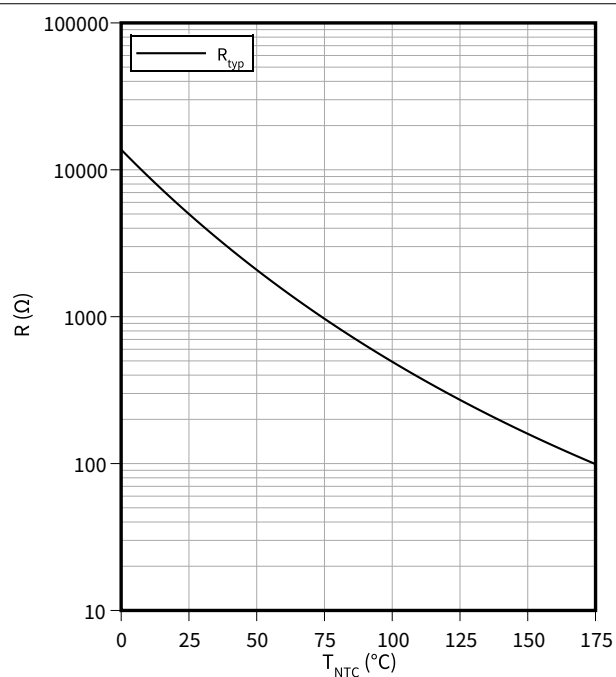
transient thermal impedance , Diode, Inverter

$Z_{th} = f(t)$



temperature characteristic (typical), NTC-Thermistor

$$R = f(T_{NTC})$$



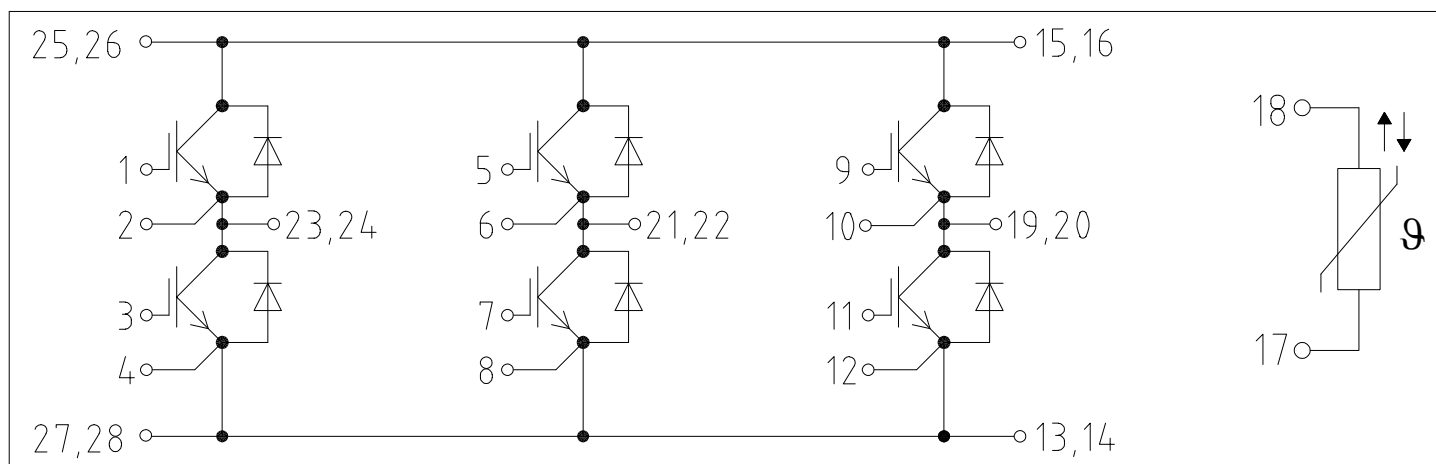


Figure 1

7 Package outlines

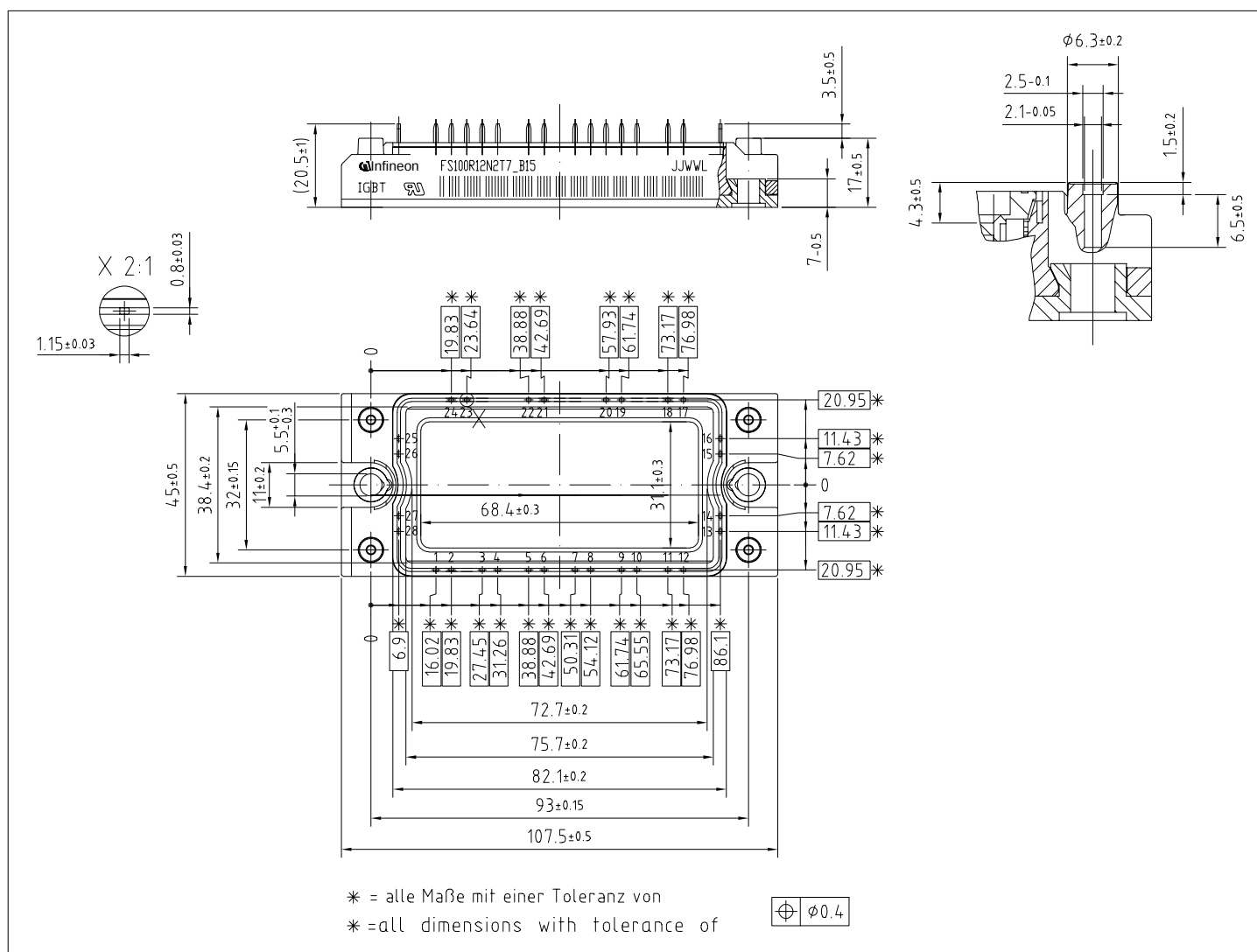


Figure 2

8 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	<i>Content</i>	<i>Digit</i>	<i>Example</i>
	Module serial number	1 – 5	71549
	Module material number	6 - 11	142846
	Production order number	12 - 19	55054991
	Date code (production year)	20 – 21	15
	Date code (production week)	22 – 23	30
Example			
			
71549142846550549911530		71549142846550549911530	

Figure 3

Revision history

Document revision	Date of release	Description of changes
1.00	2021-11-19	Initial version

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